

01-08-2007



RE:

103357719

Docket No.: 15437-0856

To the Director of the U.S. Patent and Trademark Office: Please record the attached documents or the new address(es) below.

1. Name of conveying party(ies)

Kevin T. Schmidt; Venugopalan Venkataraman

Additional name(s) of conveying party(ies) attached? ☐ Yes ☒ No**2. Name and address of receiving party(ies)**

Name: Sun Microsystems, Inc.

Internal Address: _____

Street Address: 4150 Network Circle

City: Santa Clara

State: CA

Country: USA Zip: 95054

Additional name(s) & address(es) attached? ☐ Yes ☒ No**3. Nature of conveyance/Execution Date(s):**

Execution Date(s) December 21, 2006

- ☒ Assignment ☐ Merger
- ☐ Security Agreement ☐ Change of Name
- ☐ Joint Research Agreement
- ☐ Government Interest Assignment
- ☐ Executive Order 9424, Confirmatory License
- ☐ Other _____

4. Application or patent number(s):

A. Patent Application No.(s)

☒ This document is being filed together with a new application.

B. Patent No.(s)

Additional numbers attached? ☐ Yes ☒ No**5. Name and address to whom correspondence concerning document should be mailed:**

Name: Hickman Palermo Truong & Becker LLP

Internal Address: _____

Street Address: 2055 Gateway Place, Suite 550

City: San Jose

State: CA Zip: 95110

Phone Number: 408/414-1080

Fax Number: 408/414-1076

Email Address: dledesma@hptb-law.com

6. Total number of applications and patents involved: 1**7. Total fee (37 CFR 1.21(h) & 3.41) \$40.00**

- ☐ Authorized to be charged by credit card
- ☐ Authorized to be charged to deposit account
- ☒ Enclosed
- ☐ None required (government interest not affecting title)

8. Payment Informationa. Credit Card Last 4 Numbers _____
Expiration Date _____b. Deposit Account Number _____
Authorized User Name _____**9. Signature:**

Signature

December 27, 2006

Date

Daniel D. Ledesma, Reg. No. 57,181

Name of Person Signing

Total number of pages including cover sheet, attachments, and documents:

5

Documents to be recorded (including cover sheet) should be faxed to (571) 273-0140, or mailed to:
Mail Stop Assignment Recordation Services, Director of the USPTO, P.O. Box 1450, Alexandria, V.A. 22313-1450

12-27-06

113013 U.S. PTO
11/645997

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ASSIGNMENT

KNOW ALL MEN BY THESE PRESENTS, That Whereas we, **Kevin T. Schmidt of Pasadena, California; and Venugopalan Venkataraman of Diamond Bar, California; both of USA**, have invented certain new and useful improvements in MECHANISM FOR TRANSPARENTLY INTERFACING WITH A THIRD PARTY VERSION CONTROL SYSTEM, for which an application for Letters Patent of the United States of America has been executed; and

WHEREAS **SUN MICROSYSTEMS, INC.**, a corporation duly organized and existing under the laws of Delaware, and having an address at 4150 Network Circle, Santa Clara, California 95054, is desirous of acquiring an interest therein and in the Letters Patent to be obtained therefor from the United States;

NOW THEREFORE, in consideration of the sum of one dollar (\$1.00) and other good and valuable considerations to us by **SUN MICROSYSTEMS, INC.**, the receipt whereof is hereby acknowledged, we do hereby sell, assign, transfer and set over unto **SUN MICROSYSTEMS, INC.**, its successors and assigns, the entire right, title and interest in, to and under the said application for United States Letters Patent, including all priority rights arising therefrom, all inventions therein disclosed, and any and all Letters Patent of the United States and of all other countries which may be granted for the said inventions, or any of them.

TO HAVE, HOLD and ENJOY the said inventions, the said Application, and the said Letters Patent to said **SUN MICROSYSTEMS, INC.**, its successors and assigns, to its and their own use and behoof to the full end of the term or terms for which the said Letters Patent may be granted as fully and entirely as the same would have been held and enjoyed by us had this assignment and sale not been made.

And we do hereby authorize and request the Commissioner of Patents of the United States to issue any United States Letters Patent which may be granted on the said application, or any divisional, reissue or continuation applications, or for the said inventions, or any of them, to said **SUN MICROSYSTEMS, INC.**, its successors and assigns, as assignees of the entire right, title and interest therein and thereto.

And we do hereby, for ourselves and for our legal representatives, covenant and agree with **SUN MICROSYSTEMS, INC.**, its successors and assigns, that we have granted to others no license to make, use or sell any of the said inventions, that our right, title and interest in the said inventions has not been encumbered, that we have good right and title to sell and assign the same, and that we will not execute any instrument in conflict herewith.

And we do hereby, for ourselves and for our legal representatives, further covenant and agree with **SUN MICROSYSTEMS, INC.**, its successors and assigns, that upon request we will, and they shall, execute divisional, reissue or continuation applications, amended specifications, or rightful oaths; communicate to **SUN MICROSYSTEMS, INC.**, its successors and assigns, any facts known to us relating to the said inventions or the history thereof; execute preliminary statements and testify in any interference proceedings; execute and deliver any application papers, assignments, or other instruments, and do all other acts which, in the opinion of counsel for **SUN MICROSYSTEMS, INC.**, may be necessary or convenient to secure the grant of Letters Patent to **SUN MICROSYSTEMS, INC.**, its successors and assigns, or its nominees, in the United States and in all other countries where **SUN MICROSYSTEMS, INC.**, may desire to have the said inventions, or any of them, patented, with specifications and claims in such form as shall be approved by counsel for **SUN MICROSYSTEMS, INC.**, and to vest and confirm in **SUN MICROSYSTEMS, INC.**, its successors and assigns, or its nominees, the full and complete legal and equitable title to all such Letters Patent, without further consideration than now paid but at the expense of **SUN MICROSYSTEMS, INC.**, its successors or assigns.

The undersigned hereby grants the firm of Hickman Palermo Truong & Becker, LLP of 2055 Gateway Place, Suite 550, San Jose, California 95110-1089 the power to insert on this assignment any further identification which may be necessary or desirable in order to comply with the rules of the United States Patent and Trademark Office for recordation of this document.

IN WITNESS WHEREOF, we have hereunto set our hand and seal on the date indicated below:

Date: 12/21/2006


Kevin T. Schmidt

Date: _____

Venugopalan Venkataraman

HICKMAN PALERMO TRUONG & BECKER, LLP
2055 Gateway Place, Suite 550
San Jose, California 95110-1089

IN WITNESS WHEREOF, we have hereunto set our hand and seal on the date indicated below:

Date: _____

Kevin T. Schmidt

Date: 12/21/2006

V. Venugopalan
Venugopalan Venkataraman

HICKMAN PALERMO TRUONG & BECKER, LLP
2055 Gateway Place, Suite 550
San Jose, California 95110-1089